

## A 22 V, 13.1 m $\Omega$ , 5 A Load Switch with V<sub>IN</sub> Lockout Select and MOSFET Current Monitor Output

#### **General Description**

The SLG59H1006V is a high-performance, self-powered 13.1 m $\Omega$  NMOS load switch designed for all 4.5 V to 22 V power rails up to 5 A. Using a proprietary MOSFET design, the SLG59H1006V achieves a stable 13.1 m $\Omega$  RDS<sub>ON</sub> across a wide input voltage range. In combining novel FET design and copper pillar interconnects, the SLG59H1006V package also exhibits a low thermal resistance for high-current operation.

Designed to operate over a -40  $^{\circ}$ C to 85  $^{\circ}$ C range, the SLG59H1006V is available in a low thermal resistance, RoHS-compliant, 1.6 x 3.0 mm STQFN package.

#### **Features**

- Wide Operating Input Voltage: 4.5 V to 22 V
- Maximum Continuous Current: 5 A
- Automatic nFET SOA Protection
  - 5 W SOA Protection Threshold
- High-performance MOSFET Switch Low RDS<sub>ON</sub>: 13.1 mΩ at V<sub>IN</sub> = 22 V Low ΔRDS<sub>ON</sub>/ΔV<sub>IN</sub>: < 0.05 mΩ/V Low ΔRDS<sub>ON</sub>/ΔT: < 0.06 mΩ/°C</li>
- 4-Level, Pin-selectable V<sub>IN</sub> Overvoltage Lockout
- Capacitor-adjustable Inrush Current Control
- Two stage Current Limit Protection: Resistor-adjustable Active Current Limit Internal Short-circuit Current limit
- Open Drain FAULT Signaling
- MOSFET Current Analog Output Monitor: 10 μA/A
- Fast 4 kΩ Output Discharge
  - · Pb-Free / Halogen-Free / RoHS Compliant Packaging

### **Pin Configuration**



(Top View)

### **Applications**

- Power-Rail Switching
- Multifunction Printers
- Large-format Copiers
- Telecommunications Equipment
- High-performance Computing 5 V, 9 V, 12 V, and 20 V Point-of-Load Power Distribution
- Motor Drives

### Block Diagram and a 20 V / 3 A Typical Application Circuit





# A 22 V, 13.1 m $\Omega$ , 5 A Load Switch with V<sub>IN</sub> Lockout Select and MOSFET Current Monitor Output

### **Pin Description**

Pin #	Pin Name	Туре	Pin Description
1	ON	Input	A low-to-high transition on this pin initiates the operation of the SLG59H1006V's state machine. ON is an asserted HIGH, level-sensitive CMOS input with $ON_{IL} < 0.3 V$ and $ON_{V H} > 0.9 V$ . As the ON pin input circuit does not have an internal pull-down resistor, connect this pin to a general-purpose output (GPO) of a microcontroller, an application processor, or a system controller – do not allow this pin to be open-circuited.
2	SEL0	Input	As level-sensitive, CMOS inputs with $V_{IL} < 0.3 V$ and $V_{IH} > 1.65 V$ , the SEL0 (LSB) and the SEL1 (MSB) pins select one of four $V_{IN}$ overvoltage lockout thresholds. Please see the Applications Section for additional information and the Electrical Characteristics table for the $V_{IN}$ overvoltage thresholds. A logic LOW on either pin is achieved by connecting the pin of interest to GND; a logic HIGH on either pin is achieved by connecting a 10 k $\Omega$ external resistor from the pin in question to the system's local logic supply.
3	GND	GND	Pin 3 is the main ground connection for the SLG59H1006V's internal charge pump, its gate driver and current-limit circuits as well as its internal state machine. Therefore, use a short, stout connection from Pin 3 to the system's analog or power plane.
4-8	VIN	MOSFET	VIN supplies the power for the operation of the SLG59H1006V, its internal control circuitry, and the drain terminal of the nFET load switch. With 5 pins fused together at VIN, connect a 47 $\mu$ F (or larger) low-ESR capacitor from this pin to ground. Capacitors used at VIN should be rated at 50 V or higher.
9-13	VOUT	MOSFET	Source terminal of n-channel MOSFET (5 pins fused for VOUT). Connect a 22 $\mu$ F (or larger) low-ESR capacitor from this pin to ground. Capacitors used at VOUT should be rated at 50 V or higher.
14	SEL1	Input	Please see SEL0 Pin Description above
15	FAULT	Output	An open drain output, $\overline{FAULT}$ is asserted within $\overline{TFAULT}_{LOW}$ when a V <sub>IN</sub> overvoltage, a current-limit, or an over-temperature condition is detected. $\overline{FAULT}$ is deasserted within $\overline{TFAULT}_{HIGH}$ when the fault condition is removed. Connect an 100 k $\Omega$ external resistor from the FAULT pin to local system logic supply.
16	CAP	Output	A low-ESR, stable dielectric, ceramic surface-mount capacitor connected from CAP pin to GND sets the V <sub>OUT</sub> slew rate and overall turn-on time of the SLG59H1006V. For best performance, the range for C <sub>SLEW</sub> values are 10 nF $\leq$ C <sub>SLEW</sub> $\leq$ 20 nF – please see typical characteristics for additional information. Capacitors used at the CAP pin should be rated at 10 V or higher. Please consult Applications Section on how to select C <sub>SLEW</sub> based on V <sub>OUT</sub> slew rate and loading conditions.
17	IOUT	Output	IOUT is the SLG59H1006V's power MOSFET load current monitor output. As an analog current output, this signal when applied to a ground-reference resistor generates a voltage proportional to the current through the n-channel MOSFET. The $I_{OUT}$ transfer characteristic is typically 10 µA/A with a voltage compliance range of 0.5 V ≤ $V_{IOUT}$ ≤ 4 V. Optimal $I_{OUT}$ linearity is exhibited for 0.5 A ≤ $I_{DS}$ ≤ 5 A. In addition, it is recommended to bypass the IOUT pin to GND with a 0.18 nF capacitor.
18	RSET	Input	A 1%-tolerance, metal-film resistor between 18 k $\Omega$ and 91 k $\Omega$ sets the SLG59H1006V's active current limit. A 91 k $\Omega$ resistor sets the SLG59H1006V's active current limit to 1 A and a 18 k $\Omega$ resistor sets the active current limit to 5 A.

## A 22 V, 13.1 m $\Omega,$ 5 A Load Switch with $V_{IN}$ Lockout Select and MOSFET Current Monitor Output

### **Ordering Information**

Part Number	Туре	Production Flow
SLG59H1006V	STQFN 18L FC	Industrial, -40 °C to 85 °C
SLG59H1006VTR	STQFN 18L FC (Tape and Reel)	Industrial, -40 °C to 85 °C

### **Absolute Maximum Ratings**

Parameter	Description	Conditions	Min.	Тур.	Max.	Unit
		Continuous	-0.3		30	V
V <sub>IN</sub> to GND	Load Switch Input Voltage to GND	Maximum pulsed V <sub>IN</sub> , pulse width < 0.1 s			32	V
V <sub>OUT</sub> to GND	Load Switch Output Voltage to GND		-0.3		V <sub>IN</sub>	V
ON, SEL[1,0], CAP, RSET, IOUT, and FAULT to GND	ON, <u>SEL[1,</u> 0], CAP, RSET, IOUT, and FAULT Pin Voltages to GND		-0.3		7	V
Τ <sub>S</sub>	Storage Temperature		-65		150	°C
ESD <sub>HBM</sub>	ESD Protection	Human Body Model	2000			V
ESD <sub>CDM</sub>	ESD Protection	Charged Device Model	500			V
MSL	Moisture Sensitivity Level			1		
$\theta_{JA}$	Thermal Resistance	1.6 x 3.0 mm 18L STQFN; De- termined with the device mount- ed onto a 1 in <sup>2</sup> , 1 oz. copper pad of FR-4 material		40		°C/W
MOSFET IDS <sub>CONT</sub>	Continuous Current from VIN to VOUT	T <sub>J</sub> < 150 °C			5	А
MOSFET IDS <sub>PEAK</sub>	Peak Current from VIN to VOUT	Maximum pulsed switch current, pulse width < 1 ms			6	А
Note: Stresses greate	r than those listed under "Absolute Maximu	um Ratings" may cause permanent da	mage to th	e device.	This is a str	ess rating

lote: Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

#### **Electrical Characteristics**

 $4.5 \text{ V} \le \text{V}_{\text{IN}} \le 22 \text{ V}; \text{ C}_{\text{IN}} = 47 \text{ }\mu\text{F}, \text{ T}_{\text{A}} = -40 \text{ }^{\circ}\text{C} \text{ to } 85 \text{ }^{\circ}\text{C}, \text{ unless otherwise noted. Typical values are at }\text{T}_{\text{A}} = 25 \text{ }^{\circ}\text{C}$ 

Parameter	Description	Conditions	Min.	Тур.	Max.	Unit
V <sub>IN</sub>	Operating Input Voltage		4.5		22	V
		V <sub>IN</sub> ↑; SEL[1,0] = [0,0]	5.6	6	6.3	V
M		V <sub>IN</sub> ↑; SEL[1,0] = [0,1]	10.2	10.8	11.4	V
VIN(OVLO)	VIN Overvoltage Lockout Threshold	V <sub>IN</sub> ↑; SEL[1,0] = [1,0]	13.5	14.4	15.2	V
		V <sub>IN</sub> ↑; SEL[1,0] = [1,1]	22.6	24	25.2	V
V <sub>IN(UVLO)</sub>	V <sub>IN</sub> Undervoltage Lockout Threshold	V <sub>IN</sub> ↓	2.4		3.8	V
Ι <sub>Q</sub>	Quiescent Supply Current	ON = HIGH; I <sub>DS</sub> = 0 A		0.5	0.6	mA
I <sub>SHDN</sub>	OFF Mode Supply Current	ON = LOW; I <sub>DS</sub> = 0 A		1	3	μA
RDS <sub>ON</sub>		T <sub>A</sub> = 25 °C; I <sub>DS</sub> = 0.1 A		13.1	14	mΩ
	ON Resistance	T <sub>A</sub> = 85 °C; I <sub>DS</sub> = 0.1 A		16.8	18	mΩ
MOSFET IDS	Current from VIN to VOUT	Continuous			5	А

#### **Datasheet**

#### 2-Feb-2022

## A 22 V, 13.1 m $\Omega$ , 5 A Load Switch with V<sub>IN</sub> Lockout Select and MOSFET Current Monitor Output

#### **Electrical Characteristics (continued)**

 $4.5 \text{ V} \le \text{V}_{\text{IN}} \le 22 \text{ V}; \text{ C}_{\text{IN}} = 47 \text{ }\mu\text{F}, \text{ T}_{\text{A}} = -40 \text{ }^{\circ}\text{C} \text{ to } 85 \text{ }^{\circ}\text{C}, \text{ unless otherwise noted. Typical values are at }\text{T}_{\text{A}} = 25 \text{ }^{\circ}\text{C}$ 

Parameter	Description	Conditions	Min.	Тур.	Max.	Unit
1	Active Current Limit, I <sub>ACL</sub>	V <sub>OUT</sub> > 0.5 V; R <sub>SET</sub> = 30.1 kΩ	2.8	3.2	3.6	A
LIMIT	Short-circuit Current Limit, I <sub>SCL</sub>	V <sub>OUT</sub> < 0.5 V		0.5		Α
T <sub>ACL</sub>	Active Current Limit Response Time			120		μs
R <sub>DISCHRG</sub>	Output Discharge Resistance		3.5	4.4	5.3	kΩ
	MOSFET Current Analog Monitor	I <sub>DS</sub> = 1 A	9.3	10	10.7	μA
IOUT	Output	I <sub>DS</sub> = 3 A	28.5	30	31.5	μA
T <sub>IOUT</sub>	I <sub>OUT</sub> Response Time to Change in Main MOSFET Current	C <sub>IOUT</sub> = 180 pF; Step load 0 to 2.4 A; 0% to 90% I <sub>OUT</sub>		45		μs
C <sub>LOAD</sub>	Output Load Capacitance	$C_{LOAD}$ connected from VOUT to GND		22		μF
T	ON Delay Time	50% ON to 10% V <sub>OUT</sub> †; V <sub>IN</sub> = 4.5 V; C <sub>SLEW</sub> = 10 nF; R <sub>LOAD</sub> = 100 Ω, C <sub>LOAD</sub> = 10 μF		0.3	0.5	ms
'ON_Delay		50% ON to 10% V <sub>OUT</sub> $\uparrow$ ; V <sub>IN</sub> = 22 V; C <sub>SLEW</sub> = 10 nF; R <sub>LOAD</sub> = 100 Ω, C <sub>LOAD</sub> = 10µF		0.7	1.2	ms
		50% ON to 90% V <sub>OUT</sub> ↑	Set by	External C	SLEW	ms
T <sub>Total_ON</sub>	Total Turn On Time	50% ON to 90% V <sub>OUT</sub> $\uparrow$ ; V <sub>IN</sub> = 4.5 V; C <sub>SLEW</sub> = 10 nF; R <sub>LOAD</sub> = 100 Ω, C <sub>LOAD</sub> = 10 μF		1.4	2.1	ms
		50% ON to 90% V <sub>OUT</sub> $\uparrow$ ; V <sub>IN</sub> = 22 V; C <sub>SLEW</sub> = 10 nF; R <sub>LOAD</sub> = 100 Ω, C <sub>LOAD</sub> = 10 µF		5	8	ms
		10% V <sub>OUT</sub> to 90% V <sub>OUT</sub> ↑	Set by	External C	SLEW	V/ms
V <sub>OUT(SR)</sub>	V <sub>OUT</sub> Slew Rate	10% V <sub>OUT</sub> to 90% V <sub>OUT</sub> ↑; V <sub>IN</sub> = 4.5 V to 22 V; C <sub>SLEW</sub> = 10 nF; R <sub>LOAD</sub> = 100 Ω, C <sub>LOAD</sub> = 10 μF	2.7	3.2	3.9	V/ms
T <sub>OFF_Delay</sub>	OFF Delay Time	50% ON to V <sub>OUT</sub> Fall Start ↓; V <sub>IN</sub> = 4.5 V to 22 V R <sub>LOAD</sub> = 100 Ω, No C <sub>LOAD</sub>		15		μs
T <sub>FALL</sub>	V <sub>OUT</sub> Fall Time	90% V <sub>OUT</sub> to 10% V <sub>OUT</sub> ; ON = HIGH-to-LOW; V <sub>IN</sub> = 4.5 V to 22 V; R <sub>LOAD</sub> = 100 $\Omega$ , No C <sub>LOAD</sub>	10.4	12.7	14.3	μs
TFAULTLOW	FAULT Assertion Time	$ \begin{array}{l} \underline{Abnormal} \ Step \ Load \ Current \ event \ to \\ FAULT \downarrow; \ I_{ACL} = 1 \ A; \ V_{IN} = 22 \ V; \\ R_{SET} = 91 \ k\Omega; \ switch \ in \ 20 \ \Omega \ load \end{array} $		80		μs
TFAULT <sub>HIGH</sub>	FAULT De-assertion Time	Delay to $\overline{FAULT}$ ↑ after fault condition is removed; $I_{ACL} = 1 A$ ; $V_{IN} = 22 V$ ; $R_{SET} = 91 k\Omega$ ; switch out 20 $\Omega$ load		180		μs
FAULT	FAULT Output Low Voltage	IFAULT = 1 mA		0.2		V
ON_V <sub>IH</sub>	ON Pin Input High Voltage		0.9		5	V
ON_V <sub>IL</sub>	ON Pin Input Low Voltage		-0.3	0	0.3	V
SEL[1,0]_V <sub>IH</sub>	SEL[1,0] pins Input High Voltage		1.65		4.5	V
SEL[1,0]_V <sub>IL</sub>	SEL[1,0] pins Input Low Voltage		-0.3		0.3	V
I <sub>ON(Leakage)</sub>	ON Pin Leakage Current	$1 \text{ V} \le \text{ON} \le 5 \text{ V} \text{ or ON} = \text{GND}$			1	μA
THERMON	Thermal Protection Shutdown Threshold			125		°C

**Datasheet** 

## A 22 V, 13.1 m $\Omega,$ 5 A Load Switch with V\_IN Lockout Select and MOSFET Current Monitor Output

### **Electrical Characteristics (continued)**

 $4.5 \text{ V} \le \text{V}_{\text{IN}} \le 22 \text{ V}; \text{ C}_{\text{IN}} = 47 \text{ }\mu\text{F}, \text{ T}_{\text{A}} = -40 \text{ }^{\circ}\text{C} \text{ to } 85 \text{ }^{\circ}\text{C}, \text{ unless otherwise noted. Typical values are at }\text{T}_{\text{A}} = 25 \text{ }^{\circ}\text{C}$ 

Parameter	Description	Conditions	Min.	Тур.	Max.	Unit
THERM <sub>OFF</sub>	Thermal Protection Restart Threshold			100		°C
Notes: 1. Refer to typical Timing Parameter vs. C <sub>SLEW</sub> performance charts for additional information when available.						

## T<sub>Total\_ON</sub>, T<sub>ON\_Delay</sub> and Slew Rate Measurement



\*Rise and Fall Times of the ON Signal are 100 ns

### **Typical Performance Characteristics**

Datasheet	Revision 1.02	
	Daga E of 21	

## RENESAS

## SLG59H1006V

## A 22 V, 13.1 m $\Omega,$ 5 A Load Switch with $V_{IN}$ Lockout Select and MOSFET Current Monitor Output

### $\text{RDS}_{\text{ON}}$ vs. Temperature, and $\text{V}_{\text{IN}}$



### $I_{ACL}$ vs. Temperature and $R_{SET}$



Datasheet		



## A 22 V, 13.1 m $\Omega$ , 5 A Load Switch with V<sub>IN</sub> Lockout Select and MOSFET Current Monitor Output

### $I_{ACL} \ vs. \ R_{SET} \ and \ V_{IN}$



### I<sub>OUT</sub> vs. MOSFET IDS and V<sub>IN</sub>



CFR0011-120-01



## A 22 V, 13.1 m $\Omega,$ 5 A Load Switch with $V_{IN}$ Lockout Select and MOSFET Current Monitor Output

### I<sub>OUT</sub> vs. Temperature and MOSFET IDS









A 22 V, 13.1 m $\Omega$ , 5 A Load Switch with V<sub>IN</sub> Lockout Select and MOSFET Current Monitor Output

### $T_{Total\_ON}$ vs. $C_{SLEW},$ $V_{IN},$ and Temperature





A 22 V, 13.1 m $\Omega,$  5 A Load Switch with V\_{IN} Lockout Select and MOSFET Current Monitor Output

### **Timing Diagram - Basic Operation including Active Current Limit Protection**





A 22 V, 13.1 m $\Omega$ , 5 A Load Switch with  $V_{IN}$  Lockout Select and MOSFET Current Monitor Output

### **Timing Diagram - Active Current Limit & Thermal Protection Operation**



Datasheet	Revision 1.02

## RENESAS

## SLG59H1006V

A 22 V, 13.1 m $\Omega$ , 5 A Load Switch with V<sub>IN</sub> Lockout Select and MOSFET Current Monitor Output

### Timing Diagram - Basic Operation including Active Current + Internal FET SOA Protection



Datasheet	Revision 1.02	
	P 40 (01	



A 22 V, 13.1 m $\Omega,$  5 A Load Switch with  $V_{IN}$  Lockout Select and MOSFET Current Monitor Output

### SLG59H1006V Application Diagram



Figure 1. Test setup Application Diagram

### **Typical Turn-on Waveforms**



Figure 2. Typical Turn ON operation waveform for V<sub>IN</sub> = 4.5 V, C<sub>SLEW</sub> = 10 nF, C<sub>LOAD</sub> = 10  $\mu$ F, R<sub>LOAD</sub> = 100  $\Omega$ 

Da	tas	he	et
_			_



### A 22 V, 13.1 m $\Omega$ , 5 A Load Switch with $V_{\mbox{\scriptsize IN}}$ Lockout Select and MOSFET Current Monitor Output



Figure 3. Typical Turn ON operation waveform for V<sub>IN</sub> = 4.5 V, C<sub>SLEW</sub> = 18 nF, C<sub>LOAD</sub> = 10  $\mu$ F, R<sub>LOAD</sub> = 100  $\Omega$ 



Figure 4. Typical Turn ON operation waveform for V<sub>IN</sub> = 20 V, C<sub>SLEW</sub> = 10 nF, C<sub>LOAD</sub> = 10  $\mu$ F, R<sub>LOAD</sub> = 100  $\Omega$ 

Datasheet	Revision 1.02	2-Feb-2022
CFR0011-120-01	Page 14 of 31	©2022 Renesas Electronics Corporation



## A 22 V, 13.1 m $\Omega,$ 5 A Load Switch with V\_{IN} Lockout Select and MOSFET Current Monitor Output



Figure 5. Typical Turn ON operation waveform for V<sub>IN</sub> = 20 V, C<sub>SLEW</sub> = 18 nF, C<sub>LOAD</sub> = 10  $\mu$ F, R<sub>LOAD</sub> = 100  $\Omega$ 

### **Typical Turn-off Waveforms**



Figure 6. Typical Turn OFF operation waveform for V<sub>IN</sub> = 4.5 V, C<sub>SLEW</sub> = 10 nF, no C<sub>LOAD</sub> , R<sub>LOAD</sub> = 100  $\Omega$ 

Datasheet	Revision 1.02	2-Feb-2022
CFR0011-120-01	Page 15 of 31	©2022 Renesas Electronics Corporation



## A 22 V, 13.1 m $\Omega,$ 5 A Load Switch with $V_{IN}$ Lockout Select and MOSFET Current Monitor Output



Figure 7. Typical Turn OFF operation waveform for V<sub>IN</sub> = 4.5 V, C<sub>SLEW</sub> = 10 nF, C<sub>LOAD</sub> = 10  $\mu$ F, R<sub>LOAD</sub> = 100  $\Omega$ 



Figure 8. Typical Turn OFF operation waveform for V<sub>IN</sub> = 20 V, C<sub>SLEW</sub> = 10 nF, no C<sub>LOAD</sub> , R<sub>LOAD</sub> = 100 Ω

Datasheet	Revision 1.02	2-Feb-2022
CFR0011-120-01	Page 16 of 31	©2022 Renesas Electronics Corporation



### A 22 V, 13.1 mΩ, 5 A Load Switch with VIN Lockout Select and MOSFET Current Monitor Output



Figure 9. Typical Turn OFF operation waveform for V<sub>IN</sub> = 20 V, C<sub>SLEW</sub> = 10 nF, C<sub>LOAD</sub> = 10  $\mu$ F, R<sub>LOAD</sub> = 100  $\Omega$ 

### **Typical ACL Operation Waveforms**



Figure 10. Typical ACL operation waveform for V<sub>IN</sub> = 4.5 V, C<sub>LOAD</sub> = 10  $\mu$ F, I<sub>ACL</sub> = 1 A, R<sub>SET</sub> = 91 k $\Omega$ 

Datasheet	Revision 1.02	2-Feb-2022
CFR0011-120-01	Page 17 of 31	©2022 Renesas Electronics Corporation



## A 22 V, 13.1 m $\Omega,$ 5 A Load Switch with $V_{IN}$ Lockout Select and MOSFET Current Monitor Output



Figure 11. Typical ACL operation waveform for V<sub>IN</sub> = 9 V, C<sub>LOAD</sub> = 10  $\mu$ F, I<sub>ACL</sub> = 1 A, R<sub>SET</sub> = 91 k $\Omega$ 

### H 500ms 500kSa/s 7 RIGOL T 🛃 🚺 2.60 V D 2.50000000 s $\sim$ Load 1 Enable VOUT 😰 DS 🖪 Max=1.16 A ≕ 5.00 V 2 = 20.0 V 3 = 1.00 A 4 = 5.00 V 1 Figure 12. Thermally induced SOA shutdown for V<sub>IN</sub> = 20 V, C<sub>LOAD</sub> = 10 $\mu$ F, I<sub>ACL</sub> = 1 A, R<sub>SET</sub> = 91 k $\Omega$

### **Typical SOA Waveforms**



A 22 V, 13.1 mΩ, 5 A Load Switch with VIN Lockout Select and MOSFET Current Monitor Output

### **Typical FAULT Operation Waveforms**



Figure 13. Typical FAULT assertion waveform for V<sub>IN</sub> = 4.5 V, C<sub>LOAD</sub> = 10  $\mu$ F, I<sub>ACL</sub> = 1 A, R<sub>SET</sub> = 91 k $\Omega$ , switch on 3.3  $\Omega$  load





Datasheet	Revision 1.02	2-Feb-2022
CFR0011-120-01	Page 19 of 31	©2022 Renesas Electronics Corporation



## A 22 V, 13.1 m $\Omega,$ 5 A Load Switch with $V_{IN}$ Lockout Select and MOSFET Current Monitor Output



Figure 15. Typical FAULT assertion waveform for V<sub>IN</sub> = 22 V, C<sub>LOAD</sub> = 10  $\mu$ F, I<sub>ACL</sub> = 1 A, R<sub>SET</sub> = 91 k $\Omega$ , switch on 20  $\Omega$  load



Figure 16. Typical FAULT de-assertion waveform for V<sub>IN</sub> = 22 V, C<sub>LOAD</sub> = 10  $\mu$ F, I<sub>ACL</sub> = 1 A, R<sub>SET</sub> = 91 k $\Omega$ , switch out 20  $\Omega$  load

Datasheet	Revision 1.02	2-Feb-2022
CFR0011-120-01	Page 20 of 31	©2022 Renesas Electronics Corporation

### A 22 V, 13.1 mΩ, 5 A Load Switch with VIN Lockout Select and MOSFET Current Monitor Output

### Applications Information

### High Voltage GreenFET Safe Operating Area Explained

Renesas's High Voltage GreenFET load switches incorporate a number of internal protection features that prevents them from damaging themselves or any other circuit or subcircuit downstream of them. One particular protection feature is their Safe Operation Area (SOA) protection. SOA protection is automatically activated under overpower and, in some cases, under overcurrent conditions. Overpower SOA is activated if package power dissipation exceeds an internal 5 W threshold longer than 2.5 ms. High Voltage GreenFET devices will quickly switch off (open circuit) upon overpower detection and automatically resume (close) nominal operation once overpower condition no longer exists.

One possible way to have an overpower condition trigger SOA protection is when High Voltage GreenFET products are enabled into heavy output resistive loads and/or into large load capacitors. It is under these conditions to follow carefully the "Safe Start-up Loading" guidance in the Applications section of the datasheet. During an overcurrent condition, High Voltage GreenFET devices will try to limit the output current to the level set by the external R<sub>SET</sub> resistor. Limiting the output current, however, causes an increased voltage drop across the FET's channel because the FET's RDS<sub>ON</sub> increased as well. Since the FET's RDS<sub>ON</sub> is larger, package power dissipation also increases. If the resultant increase in package power dissipation is higher/equal than 5 W for longer than 2.5 ms, internal SOA protection will be triggered and the FET will open circuit (switch off). Every time SOA protection is triggered, all High Voltage GreenFET devices will automatically attempt to resume nominal operation after 160 ms.

### Safe Start-up Condition

SLG59H1006V has built-in protection to prevent over-heating during start-up into a heavy load. Overloading the VOUT pin with a capacitor and a resistor may result in non-monotonic V<sub>OUT</sub> ramping. In general, under light loading on VOUT, V<sub>OUT</sub> ramping can be controlled with C<sub>SLEW</sub> value. The following equation serves as a guide:

$$C_{SLEW} = \frac{T_{RISE}}{V_{IN}} \times 4.9 \,\mu A \times \frac{20}{3}$$

where T<sub>RISE</sub> = Total rise time from 10% V<sub>OUT</sub> to 90% V<sub>OUT</sub> V<sub>IN</sub> = Input Voltage C<sub>SI FW</sub> = Capacitor value for CAP pin

When capacitor and resistor loading on VOUT during start up, the following tables will ensure VOUT ramping is monotonic without triggering internal protection:

Safe Start-up Loading for V <sub>IN</sub> = 12 V (Monotonic Ramp)			
Slew Rate (V/ms)	C <sub>SLEW</sub> (nF) <sup>2</sup>	C <sub>LOAD</sub> (μF)	R <sub>LOAD</sub> (Ω)
1	33.3	500	20
2	16.7	250	20
3	11.1	160	20
4	8.3	120	20
5	6.7	100	20

Datasheet	Revision 1.02	2-Feb-2022
CFR0011-120-01	Page 21 of 31	©2022 Renesas Electronics Corporation

## A 22 V, 13.1 m $\Omega$ , 5 A Load Switch with V<sub>IN</sub> Lockout Select and MOSFET Current Monitor Output

Safe Start-up Loading for V <sub>IN</sub> = 22 V (Monotonic Ramp)			
Slew Rate (V/ms)	C <sub>SLEW</sub> (nF) <sup>2</sup>	C <sub>LOAD</sub> (μF)	R <sub>LOAD</sub> (Ω)
0.5	66.7	500	80
1.0	33.3	250	80
1.5	22.2	160	80
2.0	16.7	120	80
2.5	13.3	100	80

Note 2: Select the closest-value tolerance capacitor.

### Setting the SLG59H1006V's Active Current Limit

R <sub>SET</sub> (kΩ)	Active Current Limit (A) <sup>3</sup>
91	1
45	2
30	3
18	5

Note 3: Active Current Limit accuracy is ±15% over voltage range and over temperature range.

#### Setting the SLG59H1006V's Input Overvoltage Lockout Threshold

As shown in the table below, SEL[1,0] selects the  $V_{IN}$  overvoltage threshold at which the SLG59H1006V's internal state machine will turn OFF (open circuit) the power MOSFET if  $V_{IN}$  exceeds the selected threshold.

SEL1	SEL0	V <sub>IN(OVLO)</sub> (Typ)
0	0	6 V
0	1	10.8 V
1	0	14.4 V
1	1	24 V

For example, SEL[1,1] would be the most appropriate setting for applications where the steady-state V<sub>IN</sub> can extend up to 20 V without causing any damage to the SLG59H1006V since the IC is 29-V tolerant.

With an activated SLG59H1006V (ON=HIGH) and at any time  $V_{IN}$  crosses the programmed  $V_{IN}$  overvoltage threshold, the state machine opens the load switch and asserts the FAULT pin within TFAULT<sub>LOW</sub>.

In applications with a deactivated or inactive SLG59H1006V ( $V_{IN} > V_{IN(UVLO)}$  and ON=LOW) and if the applied  $V_{IN}$  is higher than the programmed  $V_{IN(OVLO)}$  threshold, the SLG59H1006V's state machine will keep the load switch open circuited if the ON pin is toggled LOW-to-HIGH. In these cases, the FAULT pin will also be asserted within TFAULT<sub>LOW</sub> and will remain asserted until  $V_{IN}$  resumes nominal, steady-state operation.

In all cases, the SLG59H1006V's  $V_{IN}$  undervoltage lockout threshold is fixed at  $V_{IN(UVLO)}$ .

Datasheet	Revision 1.02	2-Feb-2022
	B 00 (01	

## A 22 V, 13.1 m $\Omega$ , 5 A Load Switch with V<sub>IN</sub> Lockout Select and MOSFET Current Monitor Output

#### **Power Dissipation**

The junction temperature of the SLG59H1006V depends on different factors such as board layout, ambient temperature, and other environmental factors. The primary contributor to the increase in the junction temperature of the SLG59H1006V is the power dissipation of its power MOSFET. Its power dissipation and the junction temperature in nominal operating mode can be calculated using the following equations:

$$PD = RDS_{ON} \times I_{DS}^{2}$$

where:

 $\begin{array}{l} \mathsf{PD} = \mathsf{Power \ dissipation, \ in \ Watts \ (W)} \\ \mathsf{RDS}_{\mathsf{ON}} = \mathsf{Power \ MOSFET \ ON \ resistance, \ in \ Ohms \ (\Omega)} \\ \mathsf{I}_{\mathsf{DS}} = \mathsf{Output \ current, \ in \ Amps \ (A)} \\ \mathsf{and} \end{array}$ 

 $T_J = PD \times \theta_{JA} + T_A$ 

where:

 $T_J$  = Junction temperature, in Celsius degrees (°C)  $\theta_{JA}$  = Package thermal resistance, in Celsius degrees per Watt (°C/W)  $T_A$  = Ambient temperature, in Celsius degrees (°C)

In current-limit mode, the SLG59H1006V's power dissipation can be calculated by taking into account the voltage drop across the load switch ( $V_{IN}$ - $V_{OUT}$ ) and the magnitude of the output current in current-limit mode ( $I_{ACL}$ ):

$$\label{eq:pd} \begin{split} \mathsf{PD} &= (\mathsf{V}_{\mathsf{IN}}\text{-}\mathsf{V}_{\mathsf{OUT}}) \times \mathsf{I}_{\mathsf{ACL}} \text{ or} \\ \mathsf{PD} &= (\mathsf{V}_{\mathsf{IN}} - (\mathsf{R}_{\mathsf{LOAD}} \times \mathsf{I}_{\mathsf{ACL}})) \times \mathsf{I}_{\mathsf{ACL}} \end{split}$$

where:

 $\begin{array}{l} \mathsf{PD} = \mathsf{Power \ dissipation, \ in \ Watts \ (W)} \\ \mathsf{V}_{\mathsf{IN}} = \mathsf{Input \ Voltage, \ in \ Volts \ (V)} \\ \mathsf{R}_{\mathsf{LOAD}} = \mathsf{Load \ Resistance, \ in \ Ohms \ (\Omega)} \\ \mathsf{I}_{\mathsf{ACL}} = \mathsf{Output \ limited \ current, \ in \ Amps \ (A)} \\ \mathsf{V}_{\mathsf{OUT}} = \mathsf{R}_{\mathsf{LOAD}} \times \mathsf{I}_{\mathsf{ACL}} \end{array}$ 

#### Layout Guidelines:

- 1. Since the VIN and VOUT pins dissipate most of the heat generated during high-load current operation, it is highly recommended to make power traces as short, direct, and wide as possible. A good practice is to make power traces with an absolute minimum widths of 15 mils (0.381 mm) per Ampere. A representative layout, shown in Figure 17, illustrates proper techniques for heat to transfer as efficiently as possible out of the device;
- 2. To minimize the effects of parasitic trace inductance on normal operation, it is recommended to connect input  $C_{IN}$  and output  $C_{LOAD}$  low-ESR capacitors as close as possible to the SLG59H1006V's VIN and VOUT pins;
- 3. The GND pin should be connected to system analog or power ground plane.
- 4. 2 oz. copper is recommended for high current operation.

Datasheet	Revision 1.02	2-Feb-2022
CFR0011-120-01	Page 23 of 31	©2022 Renesas Electronics Corporation

## A 22 V, 13.1 m $\Omega,$ 5 A Load Switch with $V_{IN}$ Lockout Select and MOSFET Current Monitor Output

### SLG59H1006V Evaluation Board:

A High Voltage GreenFET Evaluation Board for SLG59H1006V is designed according to the statements above and is illustrated on Figure 17. Please note that evaluation board has D\_Sense and S\_Sense pads. They cannot carry high currents and dedicated only for RDS<sub>ON</sub> evaluation.



Figure 17. SLG59H1006V Evaluation Board

# A 22 V, 13.1 m $\Omega$ , 5 A Load Switch with V<sub>IN</sub> Lockout Select and MOSFET Current Monitor Output



Figure 18. SLG59H1006V Evaluation Board Connection Circuit

### **Basic Test Setup and Connections**



Figure 19. SLG59H1006V Evaluation Board Connection Circuit

#### **EVB** Configuration

- 1. Based on  $V_{IN}$  voltage, set SEL0, SEL1 to GND or 5 V to configure OVLO;
- 2. Connect oscilloscope probes to D/VIN, S/VOUT, ON, etc.;
- 3. Turn on Power Supply and set desired V<sub>IN</sub> from 4.5 V...22 V range;
- 4 .Toggle the ON signal High or Low to observe SLG59H1006V operation.

Datasheet

**Revision 1.02** 

2-Feb-2022



## A 22 V, 13.1 m $\Omega,$ 5 A Load Switch with V\_{IN} Lockout Select and MOSFET Current Monitor Output

### **Test Result**

Using thermal camera, we tested thermal distribution on the PCB after 2 min power up at  $V_{IN} = 20$  V and  $I_{DS} = 4.5$  A. Please note how evenly temperature is distributed on the PCB that prove a proper design of PCB and thus other components around High Voltage GreenFET will be not overheated. High Voltage GreenFET temperature is only 17 °C above the lab ambient temperature. Top left corner displays temperature in the "x" position of thermal camera. Right corner from top to bottom displays full scale of temperatures.



Figure 20. Thermal distribution for  $V_{IN}$  = 20 V,  $I_{DS}$  = 4.5 A after 2 min power up

ta	eh	+
lica	51	



A 22 V, 13.1 m $\Omega$ , 5 A Load Switch with V<sub>IN</sub> Lockout Select and MOSFET Current Monitor Output

### Package Top Marking System Definition



Pin 1 Identifier

1006V - Part ID Field WW - Date Code Field<sup>1</sup> NNN - Lot Traceability Code Field<sup>1</sup> A - Assembly Site Code Field<sup>2</sup> RR - Part Revision Code Field<sup>2</sup>

Note 1: Each character in code field can be alphanumeric A-Z and 0-9 Note 2: Character in code field can be alphabetic A-Z

-			
Dai	tae	he	et
<b>D</b> u	LU O		



A 22 V, 13.1 m $\Omega$ , 5 A Load Switch with V<sub>IN</sub> Lockout Select and MOSFET Current Monitor Output

### **Package Drawing and Dimensions**





## **Top View**

**BTM View** 

Side View

Unit: mm

•	•						
Symbol	Min	Nom.	Max	Symbol	Min	Nom.	Max
Α	0.50	0.55	0.60	D	2.95	3.00	3.05
A1	0.005	-	0.05	E	1.55	1.60	1.65
A2	0.10	0.15	0.20	L	0.25	0.30	0.35
b	0.13	0.18	0.23	L1	0.64	0.69	0.74
е	(	).40 BSC	,	L2	0.15	0.20	0.25
L3	2.34	2.39	2.44	L4	0.13	0.18	0.23

Datasheet	Revision 1.02	2-Feb-2022
CFR0011-120-01	Page 28 of 31	©2022 Renesas Electronics Corporation



A 22 V, 13.1 m $\Omega$ , 5 A Load Switch with V<sub>IN</sub> Lockout Select and MOSFET Current Monitor Output

### SLG59H1006V 18-pin STQFN PCB Landing Pattern



Note: All dimensions shown in micrometers (µm)

		4					
IJ	а	ta	S	n	е	е	t.
_	-		-		-	-	-



# A 22 V, 13.1 m $\Omega$ , 5 A Load Switch with $V_{IN}$ Lockout Select and MOSFET Current Monitor Output

### **Tape and Reel Specifications**

Backage	# of	Nominal Max Units		Reel & Leader (min)			Trailer (min)		Tape Part	Part	
Туре	# or Pins	Package Size [mm]	per Reel	per Box	r Box [mm]	Pockets	Length [mm]	Pockets	Length [mm]	Width [mm]	Pitch [mm]
STQFN 18L 1.6x3mm 0.4P FC Green	18	1.6 x 3 x 0.55	3,000	3,000	178 / 60	100	400	100	400	8	4

### **Carrier Tape Drawing and Dimensions**

Package Type	PocketBTM Length	PocketBTM Width	Pocket Depth	Index Hole Pitch	Pocket Pitch	Index Hole Diameter	Index Hole to Tape Edge	Index Hole to Pocket Center	Tape Width
	A0	В0	K0	P0	P1	D0	E	F	w
STQFN 18L 1.6x3mm 0.4P FC Green	1.78	3.18	0.76	4	4	1.5	1.75	3.5	8



### **Recommended Reflow Soldering Profile**

Please see IPC/JEDEC J-STD-020: latest revision for reflow profile based on package volume of 2.64 mm<sup>3</sup> (nominal). More information can be found at www.jedec.org.

Datasheet	Revision 1.02	2-Feb-2022
	Page 30 of 31	



# A 22 V, 13.1 m $\Omega$ , 5 A Load Switch with V<sub>IN</sub> Lockout Select and MOSFET Current Monitor Output

### **Revision History**

Date	Version	Change
2/2/2022	1.02	Updated Company name and logo Added SOA Protection Threshold to Features Fixed typos
12/12/2018	1.01	Updated style and formatting Updated Charts Added Scopeshots Added Layout Guidelines Fixed typos
2/24/2017	1.00	Production Release

#### IMPORTANT NOTICE AND DISCLAIMER

RENESAS ELECTRONICS CORPORATION AND ITS SUBSIDIARIES ("RENESAS") PROVIDES TECHNICAL SPECIFICATIONS AND RELIABILITY DATA (INCLUDING DATASHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS OR IMPLIED, INCLUDING, WITHOUT LIMITATION, ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, OR NON-INFRINGEMENT OF THIRD-PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for developers who are designing with Renesas products. You are solely responsible for (1) selecting the appropriate products for your application, (2) designing, validating, and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, or other requirements. These resources are subject to change without notice. Renesas grants you permission to use these resources only to develop an application that uses Renesas products. Other reproduction or use of these resources is strictly prohibited. No license is granted to any other Renesas intellectual property or to any third-party intellectual property. Renesas disclaims responsibility for, and you will fully indemnify Renesas and its representatives against, any claims, damages, costs, losses, or liabilities arising from your use of these resources. Renesas' products are provided only subject to Renesas' Terms and Conditions of Sale or other applicable terms agreed to in writing. No use of any Renesas resources expands or otherwise alters any applicable warranties or warranty disclaimers for these products.

(Disclaimer Rev.1.01)

#### **Corporate Headquarters**

TOYOSU FORESIA, 3-2-24 Toyosu, Koto-ku, Tokyo 135-0061, Japan www.renesas.com

#### Trademarks

Renesas and the Renesas logo are trademarks of Renesas Electronics Corporation. All trademarks and registered trademarks are the property of their respective owners.

#### **Contact Information**

For further information on a product, technology, the most up-to-date version of a document, or your nearest sales office, please visit <u>www.renesas.com/contact-us/</u>.